

# **TX-M2542 Datasheet**

**Zigbee + BLE5.0 Combo Module**

# Notice

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## **Revision History**

<b>Revision</b>	<b>Date</b>	<b>Description</b>
0.1	2022.08.29	Initial release
1.0	2022.12.16	Modify Packing Information

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# 1. Scope

The TX-M2542 is Bluetooth LE + IEEE802.15.4 multi-standard wireless solution with internal Flash and audio support, which combines the features and functions needed for all 2.4GHz IoT standards into a module. The TX-M2542 combines the radio frequency (RF), digital processing, protocols stack software and profiles for multiple standards into a module. The module supports standards and industrial alliance specifications including Bluetooth Low Energy (up to Bluetooth 5), BLE Mesh, 6LoWPAN, Zigbee, RF4CE, HomeKit and 2.4GHz proprietary standard.

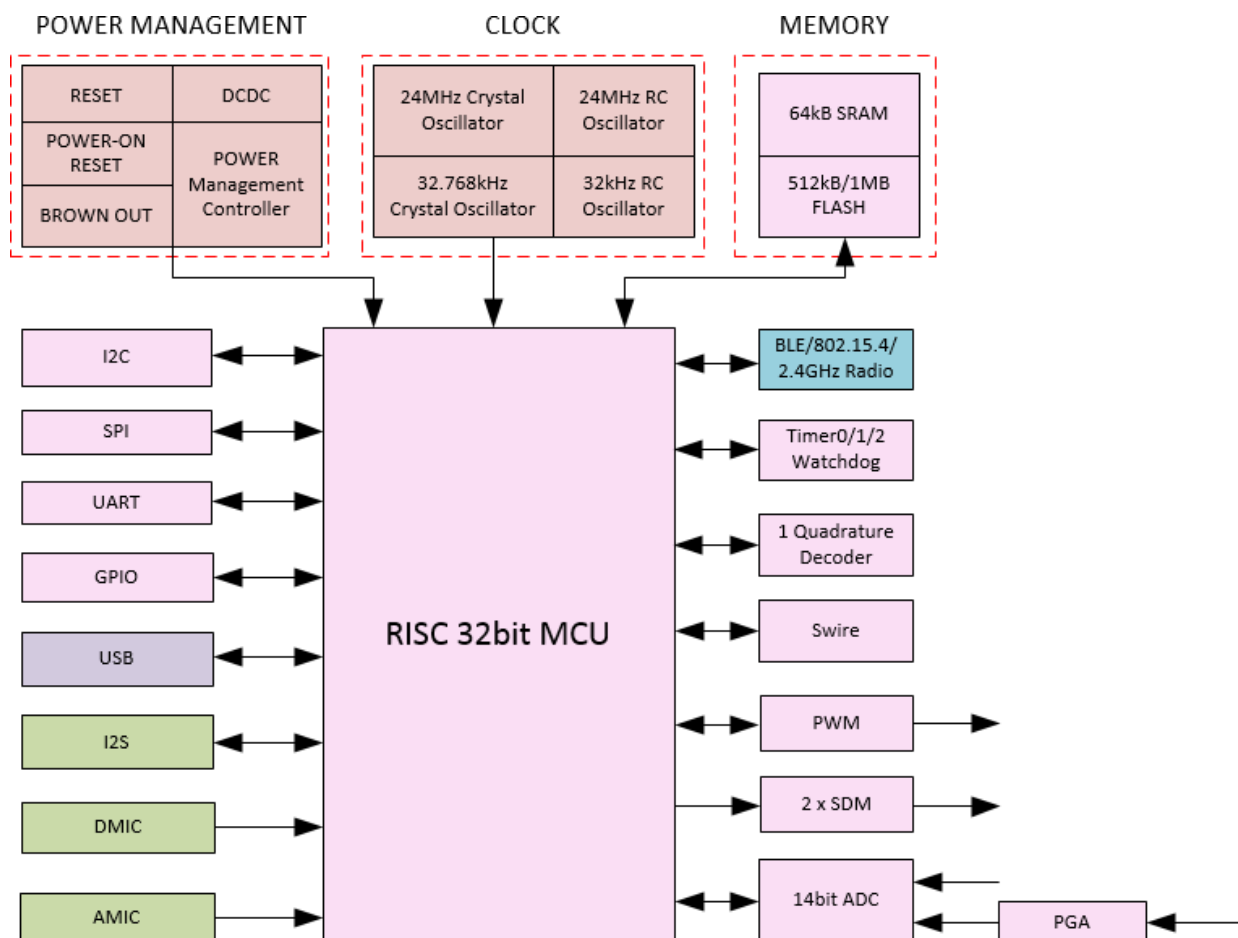
Application :

- Smartphone and tablet accessories
- RF Remote control
- Sports and fitness tracking
- Wearable devices

# 2. Features

- Embedded 32-bit high performance MCU with clock up to 48MHz.
- Program memory: internal 512KB/1M Flash
- Data memory: 64KB on-chip SRAM.
- 24MHz & 32.768KHz Crystal and 32KHz/24MHz embedded RC oscillator.
- Up to +10dBm TX power.
- RX sensitivity: -96 dBm @ BLE 1 Mbps, -99.5 dBm @ IEEE 802.15.4 250 kbps mode
- Up to 16 GPIOs
- DMIC (Digital Mic).
- AMIC (Analog Mic)
- Stereo audio output.
- UART with hardware flow control
- SPI/ I2C/ I2S/ Debug Interface.
- Up to 6 channels of PWM, 1-channel IR.
- Sensor: 14-bit 10-channel (only GPIO input) SAR ADC, with 4-channel differential input PGA/Temperature sensor.
- One quadrature decoder.
- Embedded hardware AES.

### 3. Block Diagram



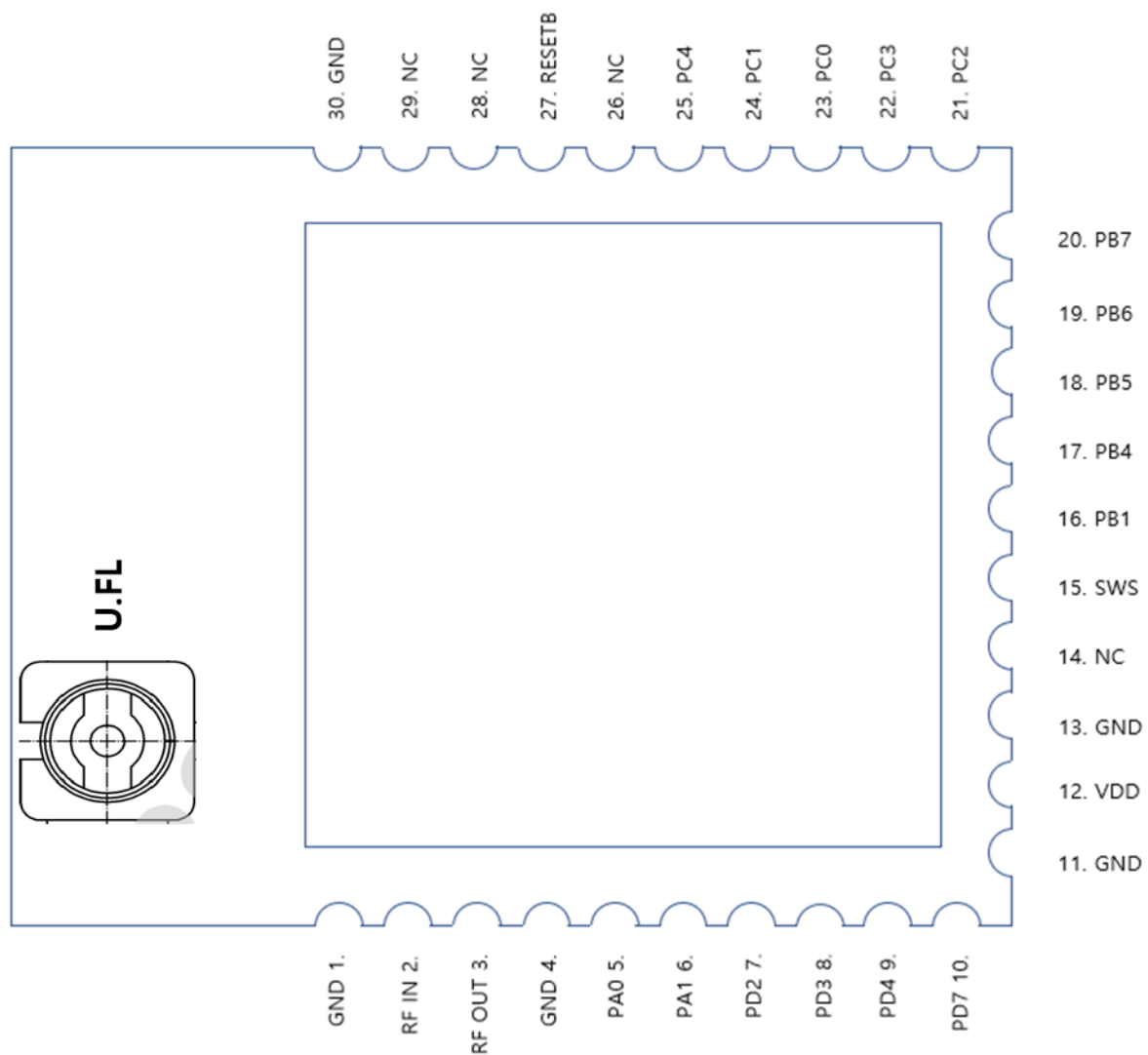
## 4. Product Information

### 4.1 Temperature Information

- Operating temperature	-40°C ~ +85°C
- Storage temperature	-40°C ~ +125°C

## 5. Pin Description

### TOP View



Pin	Name	Type	Description
1	GND	GND	Ground
2	RF IN	RF_IN	RF input
3	RF OUT	RF_OUT	RF output
4	GND	GND	Ground
5	PA0	I/O	DMIC data input / PWM0 inverting output / UART_RX / GPIO PA[0]
6	PA1	I/O	DMIC clock / UART7816 clock / I2S clock / GPIO PA[1]
7	PD2	I/O	SPI chip select (Active low) / I2S left right channel select / PWM3 output / GPIO PD[2] /
8	PD3	I/O	PWM1 inverting output / I2S serial data input / UART7816TRX (UART_TX) / GPIO PD[3]
9	PD4	I/O	Single wire master / I2S serial data output / PWM2 inverting output / GPIO PD[4]
10	PD7	I/O	SPI clock(I2C_SCK) / I2S bit clock / UART7816 TRX (UART_TX) / GPIO PD[7]
11	GND	GND	Ground
12	VDD	Vdd	3.3V Power Supply
13	GND	GND	Ground
14	NC	NC	Not Connect
15	SWS	SWS	Single Wire Slave
16	PB1	I/O	PWM4 output / UART_TX / Antenna select pin2 / Low power comparator input / SAR ADC input / GPIO PB[1]
17	PB4	I/O	SDM positive output 0 / PWM4 output / Low power comparator input/ SAR ADC input / GPIO PB[4]
18	PB5	I/O	SDM negative output 0 / PWM5 output / Low power comparator Input / SAR ADC input / GPIO PB[5]
19	PB6	I/O	SDM positive output 1 / SPI data input(I2C_SDA) / UART_RTS / Low power comparator input / SAR ADC input / GPIO PB[6]
20	PB7	I/O	SDM negative output 1 / SPI data output / UART_RX / Low power Comparator input / SAR ADC input / GPIO PB[7]
21	PC2	I/O	PWM0 output / UART 7816 TRX(UART_TX) / I2C serial data / 32KHz crystal output / PGA right channel positive input / GPIO PC[2]
22	PC3	I/O	PWM1 output / UART_RX/I2C serial clock / 32KHz crystal input / PGA right channel negative input / GPIO PC[3]
23	PC0	I/O	I2C serial data / PWM4 inverting output / UART_RTS / PGA left channel positive input / GPIO PC[0] t
24	PC1	I/O	I2C serial clock / PWM1 inverting output / PMW0 output / PGA left channel negative input / GPIO PC[1]



25	PC4	I/O	PWM2 output / UART_CTS / PWM0 inverting output / SAR ADC input / GPIO PC[4]
26	NC	NC	Not Connect
27	RESETB	Reset	Power on reset, Active low
28	NC	NC	Not Connect
29	NC	NC	Not Connect
30	GND	GND	Ground

## 6. Electrical Specification

### 6.1 Absolute Maximum Rating

Item	Min	Max	Unit
Supply Voltage	-0.3	3.6	V
Voltage on input Pin	-0.3	VDD+0.3	V
Output Voltage	0	VDD	V
Storage temperature Range	-65	150	°C

**CAUTION:** Stresses above those listed in “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### 6.2 Recommended Operating condition

Item	Min	Typ	Max	unit	Condition
Power Supply Voltage	1.8	3.3	3.6	V	
Supply rise time (from 1.6V to 2.8V)			10	ms	
Operating temperature range		-40	85	°C	

### 6.3 Current Consumption

Item	Min	Typ	Max	unit	Condition
Tx	-	4.8	-	mA	Whole chip @ 0 dBm with DCDC
Rx	-	5.3	-	mA	Whole chip
Deep sleep with 8 KB SRAM retention	-	1.0	3.1	uA	Without 32K
Deep sleep with 16 KB SRAM retention	-	1.2	3.3	uA	
Deep sleep with 32KB SRAM retention	-	1.4	3.5	uA	
Deep sleep without SRAM retention	-	0.4	-	uA	

## 6.4 AC characteristics

### 6.4.1 Digital inputs/outputs

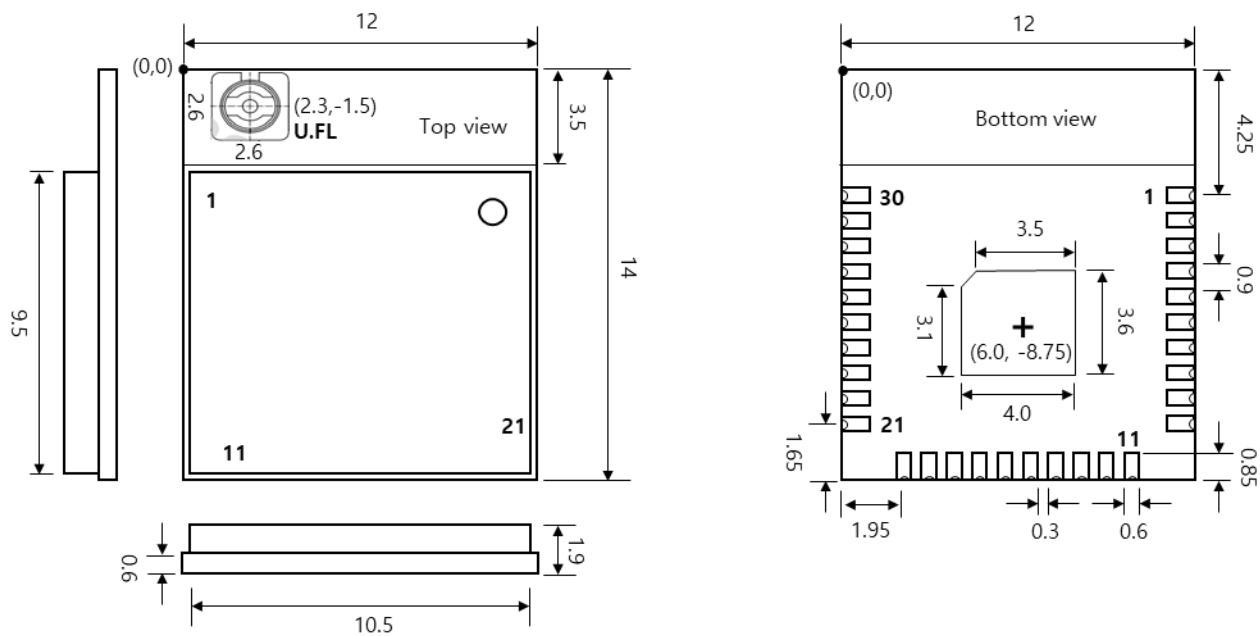
Item	Min	Typ	Max	unit	Condition
Input high voltage	0.7VDD	-	VDD	V	
Input low voltage	VSS	-	0.3VDD	V	
Output high voltage	0.9VDD	-	VDD	V	
Output low voltage	VSS	-	0.1VDD	V	

## 7. RF Specification

Nomal Condition : T=25°C, VDD=3.3V

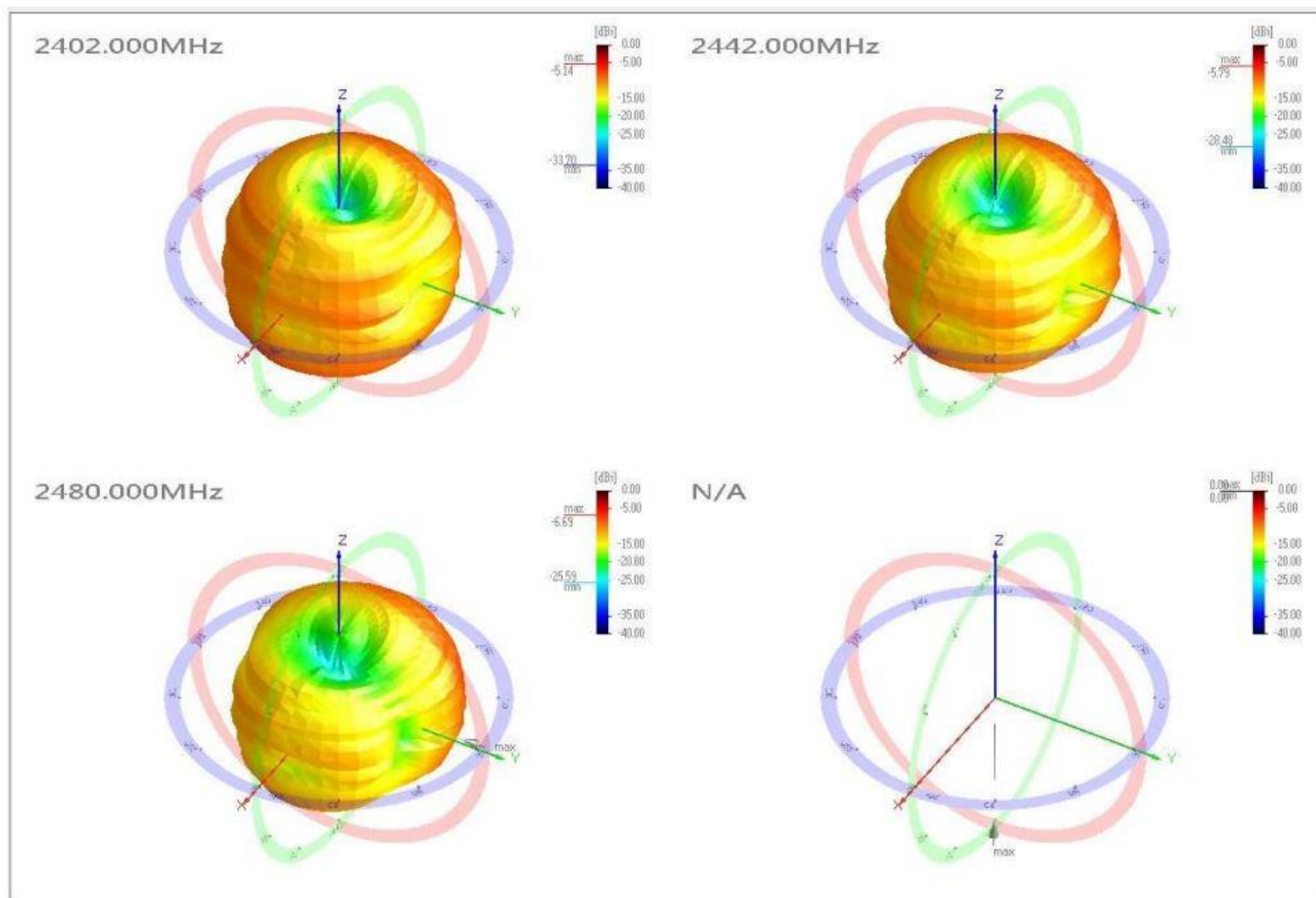
Item		Min	Typ	Max	unit	Condition
RF frequency range		2380		2500	MHz	Programmable in 1MHz step
Data rate		BLE/2.4G proprietary 1Mbps, ±250kHz deviation BLE/2.4G proprietary 2Mbps, ±500kHz deviation BLE 125kbps, ±250kHz deviation BLE 500kbps, ±250kHz deviation IEEE 802.15.4 250kbps, ±500kHz deviation 2.4G proprietary 500kbps, ±125kHz deviation 2.4G proprietary 250kbps, ±62.5kHz deviation				
BLE 1Mbps RF_Rx Performance (±250kHz Deviation)						
Sensitivity	1Mbps		-96		dBm	
Frequency offset tolerance		-250		+300	kHz	
Co-channel rejection			11		dB	Wanted signal at -67dBm
In-band blocking rejection (equal modulation interference)	+1/-1MHz offset		-1/-3		dB	Wanted signal at -67dBm
	+2/-2MHz offset		-37/-39		dB	
	≥3MHz offset		-42		dB	
Image rejection			-37		dB	Wanted signal at -67dBm
BLE 1Mbps RF_Tx Performance						
Output power, maximum setting			10	12	dBm	
Output power, minimum setting			-45		dBm	
Programmable output power range		55			dB	
Modulation 20dB bandwidth			1.4		MHz	
IEEE 802.15.4 250kbps RF_Rx Performance (±500kHz Deviation)						
Sensitivity	250kbps		-99.5		dBm	
Frequency offset tolerance		-300		+300	kHz	
Adjacent channel rejection (-1/+1 channel)			-42/-42		dB	Wanted signal at -82dBm
Adjacent channel rejection (-2/+2 channel)			-42/-42		dB	Wanted signal at -82dBm
IEEE 802.15.4 250kbps RF_Tx Performance						
Output power, maximum setting			10	12	dBm	
Output power, minimum setting (resolution)			-45		dBm	
Programmable output power range		55			dB	
Modulation 20dB bandwidth			2.7		MHz	
Error vector magnitude (EVM)				2	%	Max(10dBm) power output

## 8. Physical Dimensions (Unit : mm)

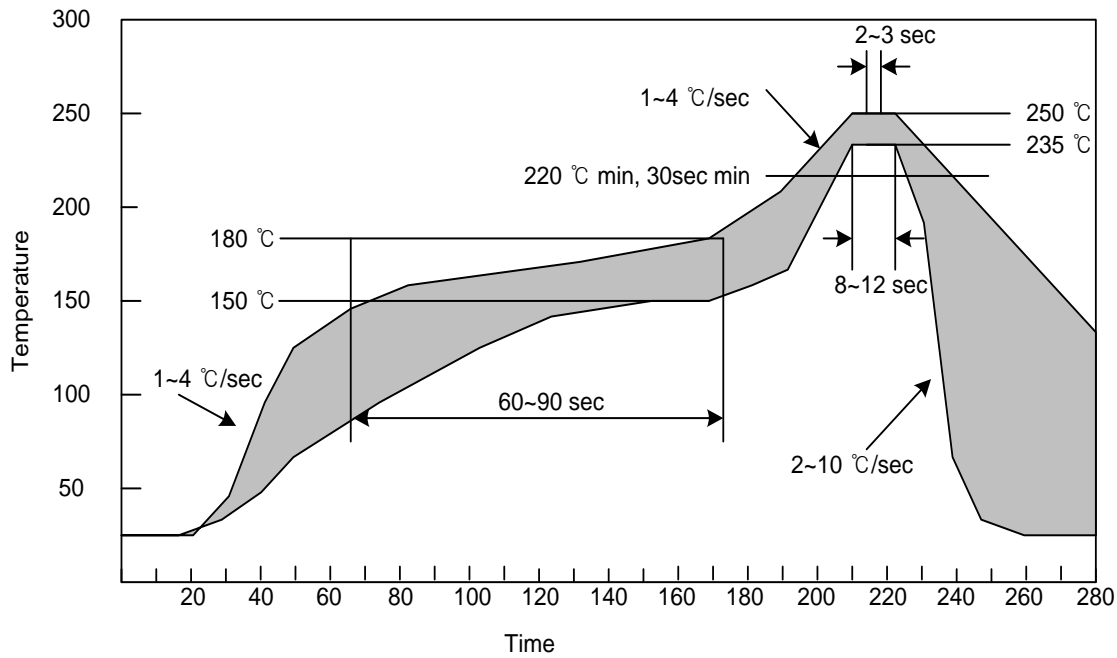




## 9.2 Antenna 3D Radiation Pattern



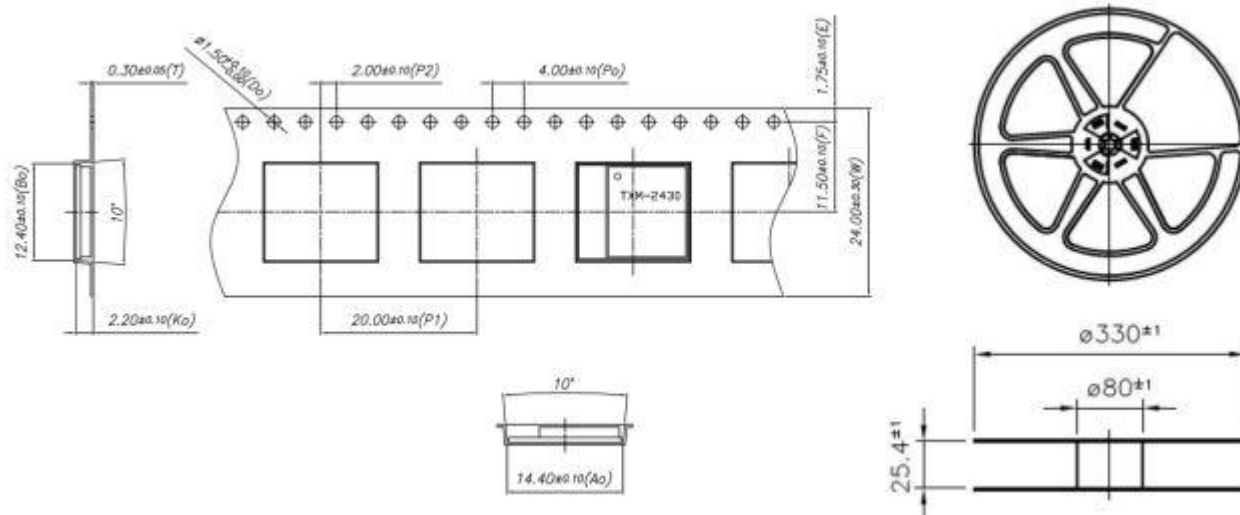
## 10. SMT Temperature Sequence (Pb-free)



Process	Parmeter	Data
Reflow Profile	Conveyer Speed	min 0.8m/min max 0.95m/min
	O2 농도	3000 ppm以下
	Pre-Heating	150~180℃ [60~90sec]
	Heating	220℃ [30~60sec]
	Peak	235~250℃

## 11. Packing Information

### 11.1 Carrier Tape and Reel Information



### 11.2 Leader and Trailer length

